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Part Number: 0545481771
Status: Active
Overview: ffc_fpc_smt
Description: 0.50mm (.020") Pitch FFC/FPC Connector, 1.20mm (.047") Height, Right Angle, SMT, ZIF, Bottom Contact Style, 17 Circuits, Lead-free, Gold (Au) Plating

Documents:
[3D Model](#)
[Drawing \(PDF\)](#)
[Product Specification PS-54548-039 \(PDF\)](#)
[RoHS Certificate of Compliance \(PDF\)](#)

General

Product Family FFC/FPC Connectors
Series 54548
Overview ffc_fpc_smt
Product Name N/A

Physical

Circuits (Loaded) 17
Contact Position Bottom
Durability (mating cycles max) 20
Entry Angle 90° Angle
Mated Height (in) 0.047 In
Mated Height (mm) 1.20 mm
Material - Metal Phosphor Bronze
Material - Plating Mating Gold
Material - Plating Termination Tin
Number of Rows 1
Orientation Right Angle
PCB Locator No
PCB Retention Yes
Packaging Type Embossed Tape on Reel
Pitch - Mating Interface (in) 0.020 In
Pitch - Mating Interface (mm) 0.50 mm
Polarized to PCB Yes
Stackable No
Temperature Range - Operating -20°C to +85°C
Termination Interface: Style Surface Mount
Wire/Cable Type FFC/FPC

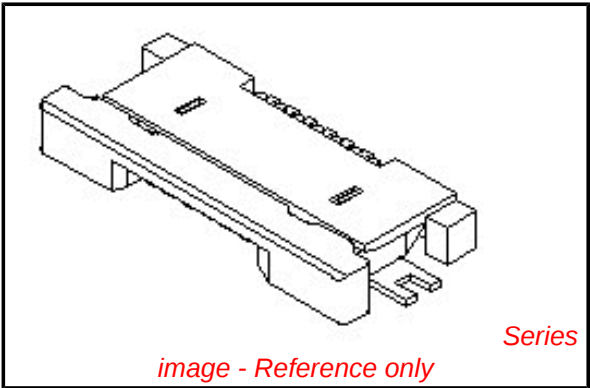
Electrical

Current - Maximum per Contact 0.5A
Voltage - Maximum 50V

Material Info

Reference - Drawing Numbers

Packaging Specification SPK-54548-001
Product Specification PS-54548-039, RPS-54548-083, RPS-54548-085, RPS-54548-091, RPS-54548-097, RPS-54548-099
Sales Drawing SD-54548-039, SD-54548-040



EU RoHS

**ELV and RoHS
Compliant**
REACH SVHC
Not Reviewed
**Halogen-Free
Status**
Not Reviewed

China RoHS

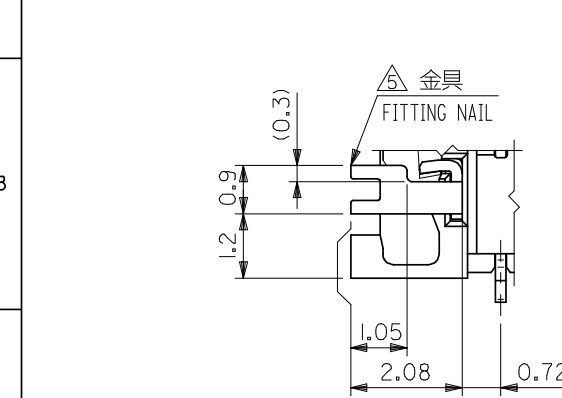
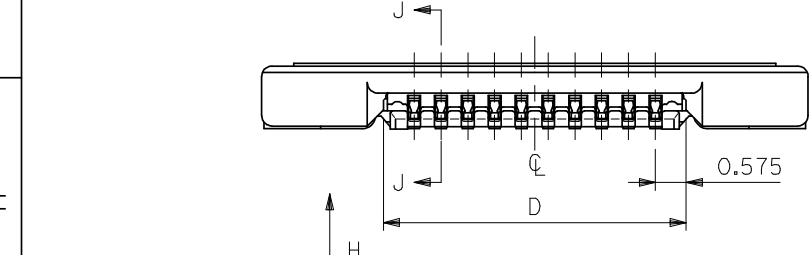
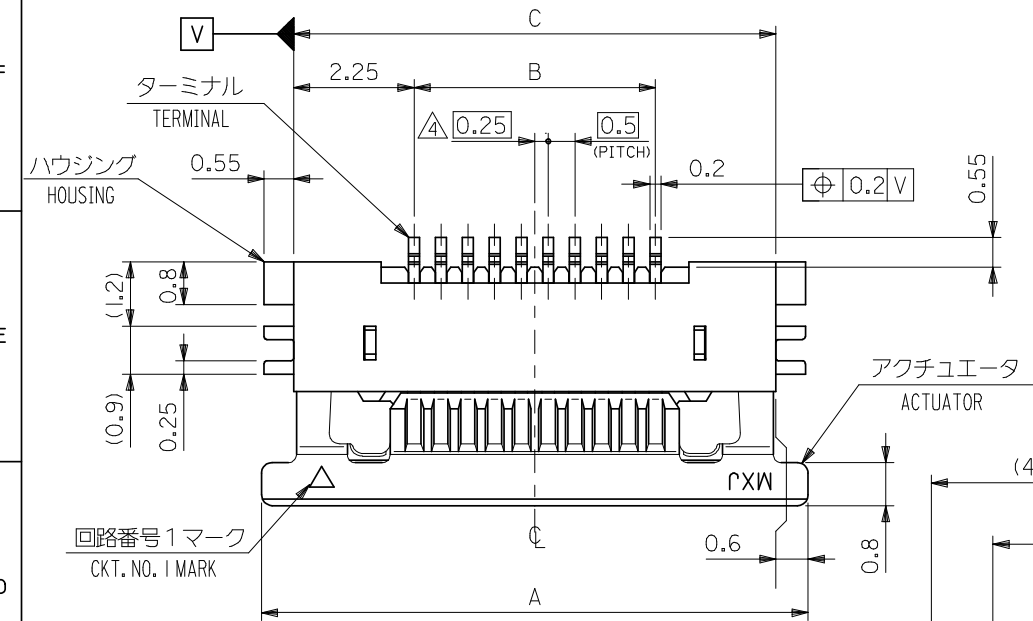


**Need more information on product
environmental compliance?**

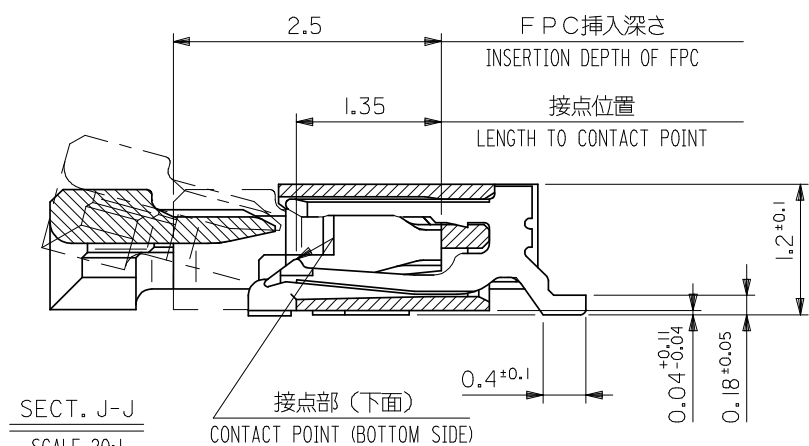
Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

Please visit the [Contact Us](#) section for any
non-product compliance questions.

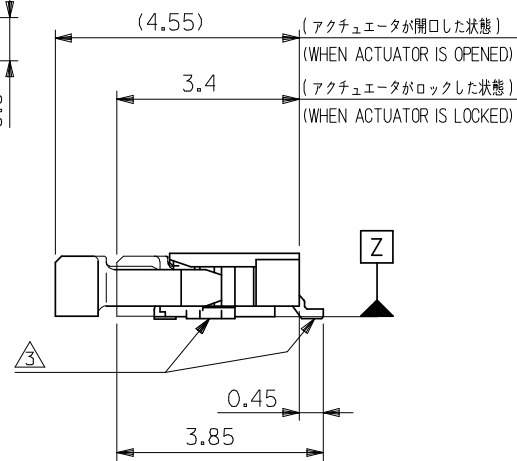
Search Parts in this Series
54548Series



VIEW H



SECT. J-J
SCALE 20:1



0.28±0.03	13.65	17.0	12.5	18.2	54548-2671	54548-2629	26
	12.65	16.0	11.5	17.2	54548-2471	54548-2429	24
	12.15	15.5	11.0	16.7	54548-2371	54548-2329	23
	11.65	15.0	10.5	16.2	54548-2271	54548-2229	22
	11.15	14.5	10.0	15.7	54548-2171	54548-2129	21
	10.65	14.0	9.5	15.2	54548-2071	54548-2029	20
	10.15	13.5	9.0	14.7	54548-1971	54548-1929	19
	9.65	13.0	8.5	14.2	54548-1871	54548-1829	18
	9.15	12.5	8.0	13.7	54548-1771	54548-1729	17
	8.65	12.0	7.5	13.2	54548-1671	54548-1629	16
	8.15	11.5	7.0	12.7	54548-1571	54548-1529	15
	7.65	11.0	6.5	12.2	54548-1471	54548-1429	14
	7.15	10.5	6.0	11.7	54548-1371	54548-1329	13
0.3±0.03	6.65	10.0	5.5	11.2	54548-1271	54548-1229	12
	6.15	9.5	5.0	10.7	54548-1171	54548-1129	11
	5.65	9.0	4.5	10.2	54548-1071	54548-1029	10
	5.15	8.5	4.0	9.7	54548-0971	54548-0929	9
	4.65	8.0	3.5	9.2	54548-0871	54548-0829	8
	4.15	7.5	3.0	8.7	54548-0771	54548-0729	7
	3.65	7.0	2.5	8.2	54548-0671	54548-0629	6
	3.15	6.5	2.0	7.7	54548-0571	54548-0529	5
	2.65	6.0	1.5	7.2	54548-0471	54548-0429	4
FPC THICKNESS	D	C	B	A	EMBOSSD TAPE ORDER No. オータ番号	製品番号 MATERIAL No.	極数 Ckt+

REVISED

EC NO: J2008-4048

DRWN:WABEI

CHKD:THARUYAMA

APPR:NUKITA

2008/06/13

2008/06/16

2008/06/16

DESCRIPTION

REV

GENERAL TOLERANCES
(UNLESS SPECIFIED)

10 UNDER ±0.2

10 OVER 30 UNDER ±0.25

30 OVER ±0.3

ANGULAR ±3 °

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
MM ONLY

DRAWN BY DATE
HSHIMABUKURO '04/02/10

CHECKED BY DATE
KTOJO '04/02/10

APPROVED BY DATE
MSASAO '04/02/10

MATERIAL NO.

SEE TABLE

SIZE
A3

SCALE
10:1

DESIGN UNITS
METRIC

THIRD ANGLE
PROJECTION

0.5 FPC CONN ZIF HSG
ASSY FOR SMT RA BTM CONT
-LEAD FREE-

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54548-**-29

MODEL No.

SD-54548-039

SHEET NO.
1 OF 2

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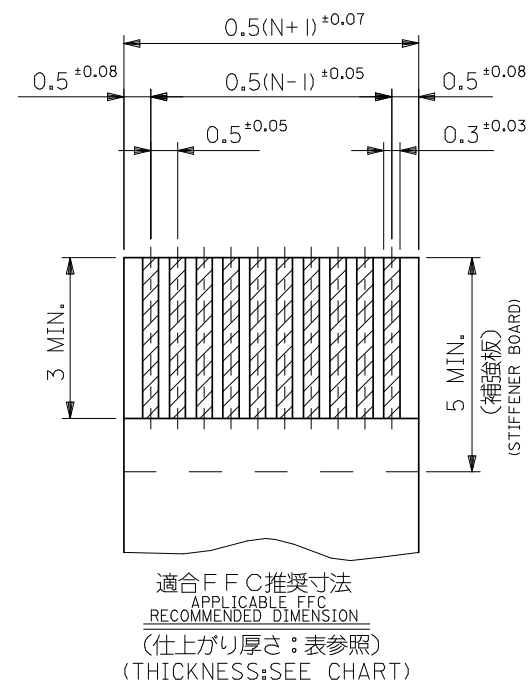
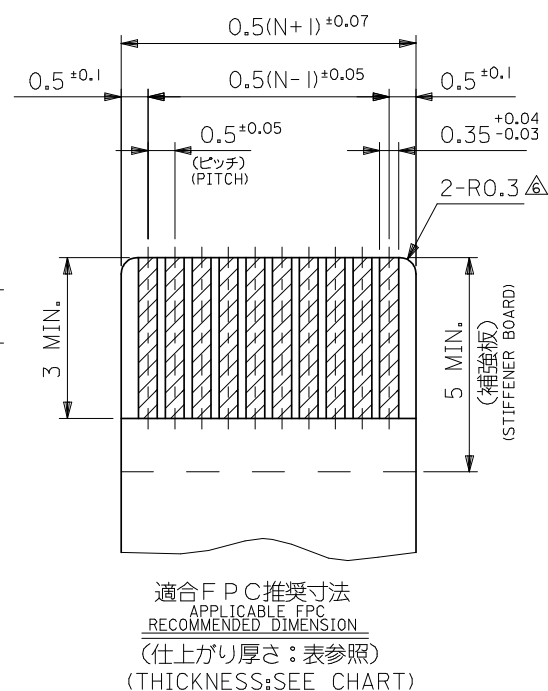
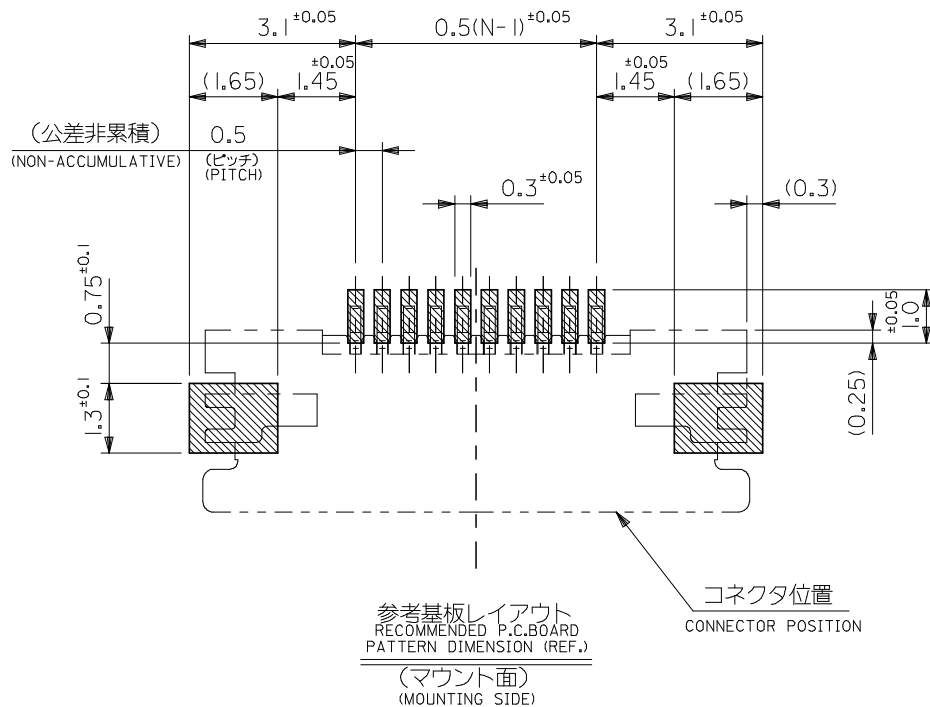
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注記 NOTES

I. 使用材料 MATERIAL

ハウジング : LCP, UL94V-0
ハウジング
アクチュエータ : PPS, UL94V-0
アクチュエータ
ターミナル : リン青銅 (t=0.2)
ターミナル
メッキ : リン青銅、鍍メッキ (t=0.2)
メッキ
接点部 : 金メッキ
CONTACT PORTION : GOLD PLATING
テール部 : 鍍メッキ
SOLDERING PORTION : TIN OVER PLATING
下地 : ニッケルメッキ
UNDER PLATING: NICKEL PLATING
金具 : リン青銅、鍍メッキ (t=0.2)
FITTING NAIL : PHOSPOR BRONZE, TIN PLATING
下地 : ニッケルメッキ
UNDER PLATING: NICKEL PLATING

2. エンボステープ梱包時は、アクチュエータがロックした状態とする。
IN THE PACKAGE, ACTUATOR OF PART NO. 54548-**-29 SHOULD BE LOCKED.
ソルダータール半田付け面のズレ量、及び金具半田付け面のズレ量は、基準面 Z
に対し上方向 0 MAX.、下方向 0.15 MAX.、とし
相互のバツキ量は 0.1 MAX. とする。
MISALIGNMENT OF SOLDER TAILS AND FITTING NAILS FROM Z
UPPER DIRECTION: 0 MAX., LOWER DIRECTION: 0.15 MAX.
OFFSET BETWEEN UPPER AND LOWER 0.1 MAX.

偶数極に適用。
APPLY FOR EVEN CIRCUIT.

パターンはくり止め用金具
FITTING NAIL FOR PREVENTION OF PEELING
OF P.C.B. PATTERN.
R0.3 は FPC 導体部にかからないこと
R0.3 MUST NOT BE OVERLAPPED TO PATTERN OF FPC.
7. 本製品は 54548-**-21 の鉛フリー (部分金メッキ) 品である。
THIS PRODUCT IS LEAD FREE OF 54548-**-21 (SELECTIVE GOLD).
8. N: 極数 N: CIRCUIT.

FPC/FFC について:

打ち抜き方向は導体側から補強板側を推奨します。
導体部については軟銅箔 35 μm または 50 μm を推奨します。

ABOUT FPC/FFC

RECOMMENDED PUNCHER DIRECTION : FROM CONDUCTOR SIDE TO STIFFENER FILM SIDE.
RECOMMENDED CONDUCTOR SPEC :
THICKNESS OF SOFT COPPER FOIL : 35 MICROMETER OR 50 MICROMETER.

FPC について:

補強フィルム材質はポリイミドを推奨します。ベースフィルムは 25 μm を推奨します。
接着剤は熱硬化接着剤を推奨します。
尚、接着剤の接点部への付着は導通不良の原因になりますので、染み出しが無い様、お願い致します。

ABOUT FPC

RECOMMENDED MATERIAL/THICKNESS.
STIFFENER FILM : POLYIMIDE
BASE FILM THICKNESS : 25 μm
BONDING AGENT : THERMOSETTING BONDING AGENT
PLEASE PUT APPROPRIATE AMOUNT OF ADHESIVE ON THE CONTACT
AREA BECAUSE THE EXTRA ADHESIVE MAY CAUSE THE DEFECT IN
ELECTRICAL CONTINUITY.

REVISED		EC NO: J2008-4048		2008/06/13		DRWN:WABEI		2008/06/16		CHKD:THARUYAMA		2008/06/16		APPR:NUKITA		DESCRIPTION		REV			
GENERAL TOLERANCES (UNLESS SPECIFIED)										DIMENSION STYLE MM ONLY				SCALE ---		DESIGN UNITS METRIC		 THIRD ANGLE PROJECTION			
10 UNDER										± 0.2		DRAWN BY HSHIMABUKURO		DATE '04/02/10		TITLE 0.5 FPC CONN ZIF HSG ASSY FOR SMT RA BTM CONT -LEAD FREE-					
10 OVER 30 UNDER										± 0.25		CHECKED BY KTOJO		DATE '04/02/10							
30 OVER										± 0.3		APPROVED BY MSASAO		DATE '04/02/10							
ANGULAR										±3 °		MATERIAL NO.				DOCUMENT NO.				SHEET NO.	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS										SEE SHEET 1				SD-54548-039				2 OF 2			
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION																					

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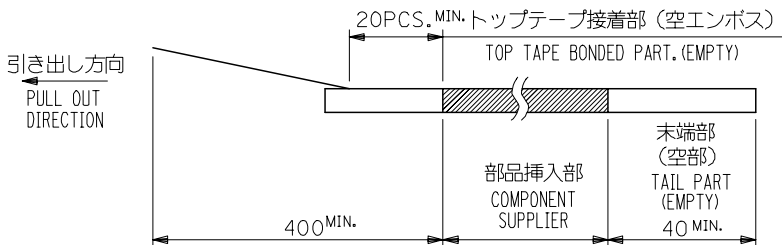
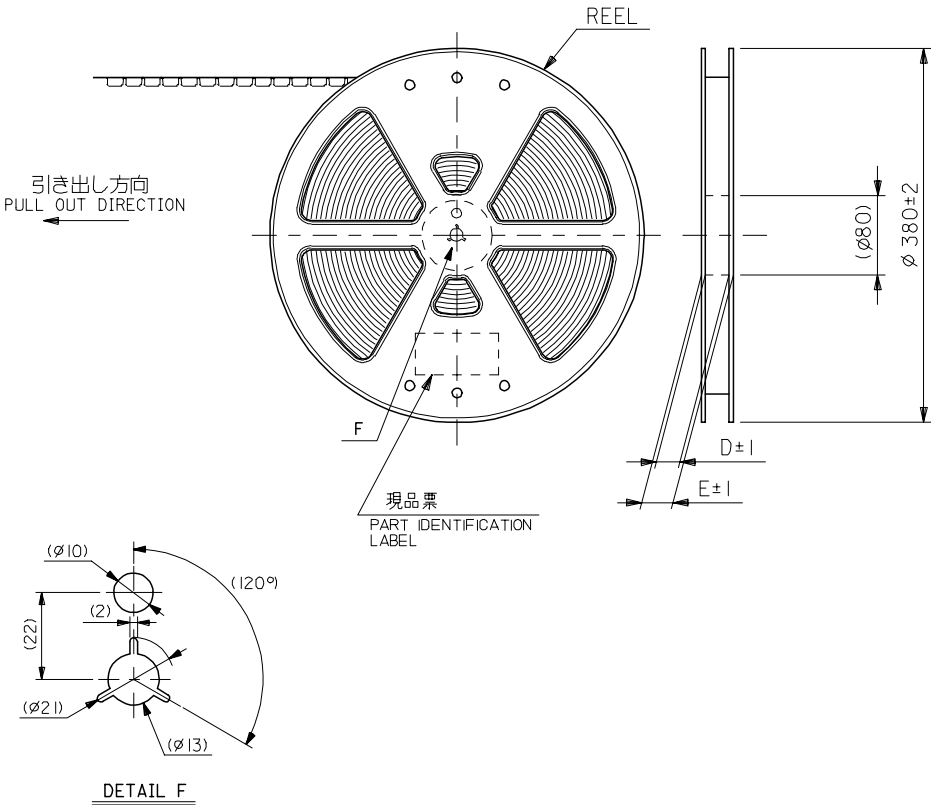
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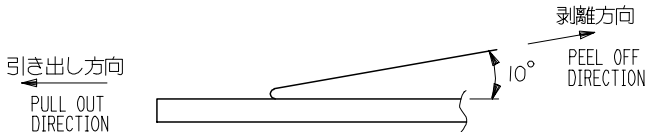
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NOTES

1. 製品詳細寸法については図面 SD-54548-039 を参照下さい。
RE DETAILED DIMENSION, SEE SD-54548-039
2. 梱包数量：3000個/リール
NUMBER OF CONNECTORS : 3000PCS/REEL
3. リードテープ長さ LEAD TAPE LENGTH



4. トップテープの剥離強度：0.1N ～ 1.3N(10gf ～ 130gf)
(剥離方向は下図参照)
尚、本規格値は出荷時に適用。(但し、輸送時に剥離が発生しないこと。)
PEELING OFF FORCE OF TOP TAPE : 0.1N ～ 1.3N(10gf ～ 130gf)
(PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.)
THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT.
PEEL OFF SHOULD NOT BE ALLOWED , DURING TRANSPORTATION.



5. 材料(MATERIAL)
キャリアテープ(CARRIER TAPE)：ポリプロピレン(POLYPROPYLENE)
トップテープ(TOPTAPE)：PET , PE , PEF
リール(REEL)：ポリスチレン (P S) <リサイクル材を含む>
POLYSTYRENE(PS) <RECYCLE MATERIAL CONTAINED>
6. 本製品は 54548-**-91 の鉛フリー(部分金メッキ)品である。
THIS PRODUCT IS LEAD FREE OF 54548-**-91 (SELECTIVE GOLD).

REVISED EC NO: J2006-3468 DRAWN: NABEI CHKD: KTOYODA APPR: NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE ---	54548-***71		MODEL No.		
				MM ONLY			DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
		10 UNDER	±0.2	DRAWN BY HSHIMABUKURO	DATE '04/02/10	0.5 FPC CONN ZIF HSG ASSY RA BOTTOM CONTACT -LEAD FREE-					
		10 OVER 30 UNDER	±0.25	CHECKED BY KTOJO	DATE '04/02/10						
		30 OVER	±0.3	APPROVED BY MSASAO	DATE '04/02/10	molex MOLEX INCORPORATED					
	ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.				SHEET NO.		
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-54548-040				1 OF 4		
REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION										

